Specification of Thermoelectric Module

TES1-07125

Description

The 71 couples, 23mm x 23mm size module is a single stage module which is made of our high performance ingot to achieve superior cooling performance and 70 $^{\circ}$ C or larger delta Tmax, is designed for superior cooling and heating applications. Beyond the standard below, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

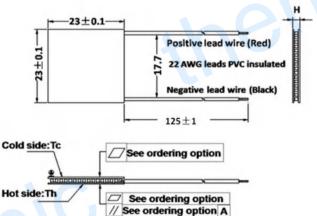
Performance Specification Sheet

Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

Th (°C)	27	50	Hot side temperature at environment: dry air, N ₂	
DT _{max} (°C)	70	79 Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side		
U _{max} (Voltage)	9.0	9.4	Voltage applied to the module at DT _{max}	
I _{max} (Amps)	3.2	3.2	DC current through the modules at DT _{max}	
Q _{Cmax} (Watts)	17.8	19.7	Cooling capacity at cold side of the module under DT=0 °C	
AC resistance (Ohms)	2.10	2.23	The module resistance is tested under AC	
Tolerance (%)	± 10		For thermal and electricity parameters	

Geometric Characteristics Dimensions in millimeters



Manufacturing Options

A. Solder:	B. Sealant:
1. T100: BiSn (Tmelt=138°C)	1. NS: No sealing (Standard)
2. T200: CuAgSn (Tmelt = 217°C)	2. SS: Silicone sealant
3. T240: SbSn (Tmelt = 240°C)	3. EPS: Epoxy sealant
C. Ceramics:	D. Ceramics Surface Options:
1. Alumina (Al ₂ O ₃ , white 96%)	1. Blank ceramics (not metalized)
2. Aluminum Nitride (AlN)	2. Metalized

- 2. Aluminum Nitride (AlN)

Naming for the Module

Ordering Option

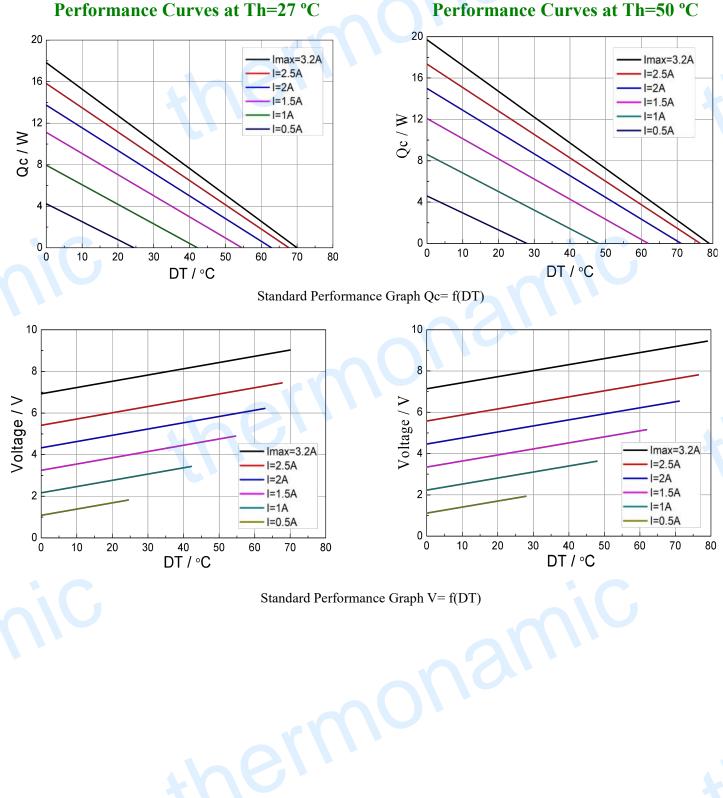
Suffix	Thickness H (mm)	Flatness/ Parallelism (mm)	Lead wire length(mm) Standard/Optional length	TES1-07125 - X - X - X - X $T T Ceramics$
TF	0:3.6± 0.1	0: 0.07/0.07	125±1/Specify	Flatness/ Parallelism Sealant
TF	$1:3.6 \pm 0.03$:3.6 ± 0.03 1: 0.025/0.025 125±1/Specify		
Eg. TF01: Thickness 3.6± 0.1 (mm) and Flatness 0.025/0.025 (mm)				T100: BiSn(Tmelt=138°C)
				NS: No sealing AlO: Alumina white 9

AlO: Alumina white 96%

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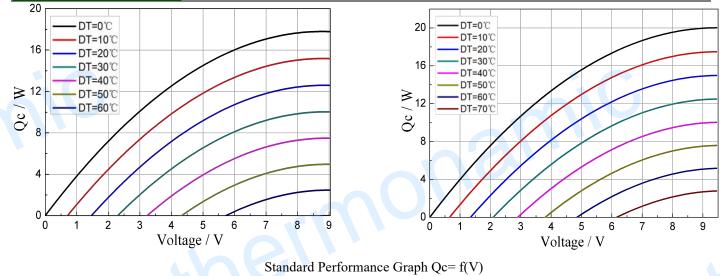
TES1-07125



Performance Curves at Th=27 °C

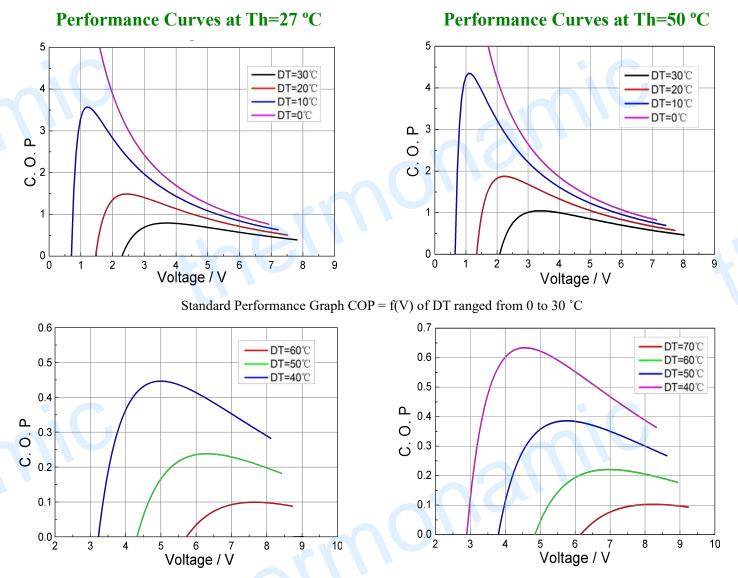
Thermonamic Module

High Performance and Highly Reliable Solution for Cooling and Heating Applications



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TES1-07125



Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power ($V \times I$).

Operation Caution

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating nermonan
- Operation below Imax or Vmax
- Work under DC

Note: All specifications subject to change without notice.

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